# PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Takao INOUE	07/29/2009
Tetsushi KOKUBO	08/17/2009
Hitoshi MUKAI	07/30/2009
Hirofumi HIBI	07/30/2009
Tetsujiro KONDO	08/07/2009

### **RECEIVING PARTY DATA**

Name:	SONY CORPORATION
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	Japan
Postal Code:	108-0075

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12479252

# **CORRESPONDENCE DATA**

(703)413-2220 Fax Number:

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

(703) 413-3000 Phone: Email: aassefa@oblon.com Correspondent Name: Oblon, Spivak, et al. Address Line 1: 1940 Duke Street

Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	343067US8
NAME OF SUBMITTER:	Aynalem Assefa

**PATENT REEL: 023130 FRAME: 0884** 

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Total Attachments: 6 source=343067USAssignment#page1.tif source=343067USAssignment#page2.tif source=343067USAssignment#page3.tif source=343067USAssignment#page4.tif source=343067USAssignment#page5.tif

source=343067USAssignment#page6.tif

Docket Number: 343067US8

#### ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a solc inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

VIDEO-SIGNAL PROCESSING APPARATUS, VIDEO-SIGNAL PROCESSING METHOD, AND VIDEO-

SIGNAL PROCESSING SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, 108-0075 Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and logal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuncration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Lotters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I heroby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/479,252 Filing Date: June 5, 2009

This assignment executed on the dates indicated below.

Takao INQUE	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
Takao Inoue	July 29, 2009
Signature of first or sole inventor	Date of this assignment

Tetsushi KOKUBO	
Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor	
Signature of second inventor	Date of this assignment
Hitoshi MUKAI	
Name of third inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of third inventor	:
Kitoshi Mukai	Jul. 30, 200 9  Date of this assignment
Signature of third inventor	Date of this assignment
Hirofumi HIBI	·
Name of fourth inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	·
Residence of fourth inventor	
Hirfumi Hiti	Jul. 30, 2009
Signature of fourth inventor	Date of this assignment
Tetaujiro KONDO	
Name of fifth inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of fifth inventor	
Simple of 68h inventor	Date of this assignment

Signature of fifth inventor

**PATENT** 

REEL: 023130 FRAME: 0887

## Docket Number: 343067US8

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And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

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Kanagawa, Japan	
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Signature of first or sole inventor	Date of this assignmen

Tetsushi KOKUBO	Execution date of U.S. Patent Application
Name of second inventor	Execution date of U.S. Facilit Application
Kanagawa, Japan	
Residence of socond inventor	
Totanki Hobelov	Auf 17, 2009  Date of this assignment
Signature of second inventor	Date of this assignment
Hitoshi MUKAI	Execution date of U.S. Patent Application
Name of third inventor	Execution date of 0.0. I seems Pro-
Kanagawa, Japan	
Residence of third inventor	
43.11	Date of this assignment
Signature of third inventor	
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Hirofumi HIBI	Execution date of U.S. Patent Application
Name of fourth inventor	
Kanagawa, Japan	
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Signature of router average	
Tetsujiro KONDO	Execution date of U.S. Patent Application
Name of fifth inventor	Execution date of U.S. Patent Approxima
Tokyo, Japan	
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Kanagawa, Japan	
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Tetsujiro KONDO	Execution date of U.S. Patent Application
Name of fifth inventor	Execution date of U.S. 1 and 1 Apparent
Tokyo, Japan	
Residence of fifth inventor	1 1 2 2 7 9
Signature of fifth inventor	Augus 47, 2009 Date of this assignment
Signature of fifth inventor	Date of the societies

**RECORDED: 08/21/2009** 

**PATENT** 

REEL: 023130 FRAME: 0891